The Wideband IC Line

RF LDMOS Wideband Integrated Power Amplifiers

The MW4IC2230 wideband integrated circuit is designed for W-CDMA base station applications. It uses Motorola's newest High Voltage (26 to 28 Volts) LDMOS IC technology and integrates a multi-stage structure. Its wideband On-Chip design makes it usable from 1600 to 2400 MHz. The linearity performances cover all modulations for cellular applications: GSM, GSM EDGE, TDMA, CDMA and W-CDMA.

Final Application

Typical Single-carrier W-CDMA Performance: $V_{DD} = 28$ Volts, $I_{DQ1} = 60$ mA, $I_{DQ2} = 350$ mA, $P_{out} = 5$ Watts Avg., f = 2140 MHz, Channel Bandwidth = 3.84 MHz, Peak/Avg. = 8.5 dB @ 0.01% Probability on CCDF.

Power Gain — 31 dB
Drain Efficiency — 15%

ACPR @ 5 MHz = -45 dBc @ 3.84 MHz Bandwidth

Driver Application

Typical Single-carrier W-CDMA Performance: V_{DD} = 28 Volts, I_{DQ1} = 60 mA, I_{DQ2} = 350 mA, P_{out} = 0.4 Watts Avg., f = 2140 MHz, Channel Bandwidth = 3.84 MHz, Peak/Avg. = 8.5 dB @ 0.01% Probability on CCDF. Power Gain — 31.5 dB ACPR @ 5 MHz = -53.5 dBc @ 3.84 MHz Bandwidth

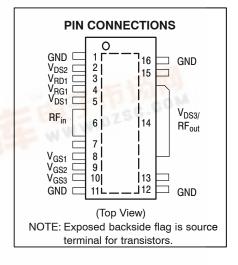
- Capable of Handling 3:1 VSWR, @ 28 Vdc, 2170 MHz, 5 Watts CW Output Power
- Characterized with Series Equivalent Large-Signal Impedance Parameters
- On-Chip Matching (50 Ohm Input, DC Blocked, >5 Ohm Output)
- Integrated Temperature Compensation with Enable/Disable Function
- On-Chip Current Mirror g_m Reference FET for Self Biasing Application (1)
- Integrated ESD Protection
- Also Available in Gull Wing for Surface Mount
- In Tape and Reel. R1 Suffix = 500 Units per 44 mm, 13 inch Reel

V_{RG1} V_{DS2} V_{DS1} RF_{in} V_{GS1} V_{GS2} V_{GS3} V_{GS3} V_{GS3} V_{GS2} V_{GS3} V_{DS3}/RF_{out} V_{DS3}/RF_{out} V_{DS3}/RF_{out}

MW4IC2230MBR1 MW4IC2230GMBR1

2110-2170 MHz, 30 W, 28 V SINGLE W-CDMA RF LDMOS WIDEBAND INTEGRATED POWER AMPLIFIERS





(1) Refer to AN1987/D, Quiescent Current Control for the RF Integrated Circuit Device Family. Go to http://www.motorola.com/semiconductors/rf. Select Documentation/Application Notes - AN1987.





MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	65	Vdc
Gate-Source Voltage	V _{GS}	-0.5, +8	Vdc
Storage Temperature Range	T _{stg}	-65 to +175	°C
Operating Channel Temperature	T _J	175	°C
Input Power	P _{in}	20	dBm

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value (1)	Unit
Thermal Resistance, Junction to Case	$R_{ heta JC}$		°C/W
Stage 1		10.5	
Stage 2		5.1	
Stage 3		2.3	

ESD PROTECTION CHARACTERISTICS

Test Conditions	Class
Human Body Model	2 (Minimum)
Machine Model	M3 (Minimum)
Charge Device Model	C5 (Minimum)

MOISTURE SENSITIVITY LEVEL

Test Methodology	Rating
Per JESD 22-A113	3

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted) Characteristic

	_				
FUNCTIONAL TESTS (In Motorola Test Fixture, 50 ohm system) V _{DD} = 28 V	Vdc , $I_{DO1} = 6$	30 mA, I _{DO2} =	$350 \text{ mA}, I_{DO}$	$_{13} = 265 \text{ mA},$	
P 0.4 W Avg. f - 2110 MHz f - 2170 MHz Single-carrier W-CDMA A					

Offset. Peak/Avg. Ratio = 8.5 dB @ 0.01% Probability on CCDF.

Power Gain	G _{ps}	29	31.5	_	dB
Input Return Loss	IRL	_	-25	-10	dB
Adjacent Channel Power Ratio $P_{out} = 0.4 \text{ W Avg.}$ $P_{out} = 1.26 \text{ W Avg.}$	ACPR	_ _	-53.5 -52	-50 —	dBc
Stability (10 mW <p<sub>out<5 W CW, Load VSWR = 3:1, All Phase Angles, 24 V<vds<28 td="" v)<=""><td></td><td colspan="3">No Spurious > -60 dBc</td><td></td></vds<28></p<sub>		No Spurious > -60 dBc			

 $\textbf{TYPICAL PERFORMANCES} \text{ (In Motorola Test Fixture tuned for 0.4 W Avg. W-CDMA driver) } V_{DD} = 28 \text{ Vdc}, I_{DQ1} = 60 \text{ mA}, I_{DQ2} = 350 \text{ mA}, I_{DQ2} = 350 \text{ mA}, I_{DQ3} = 360 \text{ mA}, I_{DQ4} = 360 \text{ mA$ I_{DQ3} = 265 mA, 2110 MHz<Frequency <2170 MHz

Saturated Pulsed Output Power (f = 1 kHz, Duty Cycle 10%)	P _{sat}	_	43	_	Watts
Quiescent Current Accuracy over Temperature (-10 to 85°C)	ΔI_{QT}	_	±5	_	%
Gain Flatness in 30 MHz Bandwidth	G _F	_	0.13	_	dB
Deviation from Linear Phase in 30 MHz Bandwidth	Φ	_	±1	_	0
Delay @ P _{out} = 0.4 W CW Including Output Matching	Delay	_	1.6	_	ns
Part to Part Phase Variation	ΦΔ	_	±15	_	0

⁽¹⁾ MTTF calculator available at http://www.motorola.com/semiconductors/rf. Select Tools/Software/Application Software/Calculators to access the MTTF calculators by product.

(continued)

ELECTRICAL CHARACTERISTICS — **continued** (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
	,		71		

TYPICAL PERFORMANCES (In Motorola Reference Application Circuit tuned for 2-carrier W-CDMA signal) V_{DD} = 28 Vdc, P_{out} = 0.4 W Avg., I_{DQ1} = 60 mA, I_{DQ2} = 400 mA, I_{DQ3} = 245 mA, f1 = 2112.5 MHz, f2 = 2122.5 MHz and f1 = 2157.5 MHz, f2 = 2167.5 MHz, f2

Power Gain	G _{ps}	_	31.5	_	dB
Intermodulation Distortion	IM3	_	-52	_	dBc
Adjacent Channel Power Ratio	ACPR	_	-55	_	dBc
Input Return Loss	IRL	_	-26	_	dB

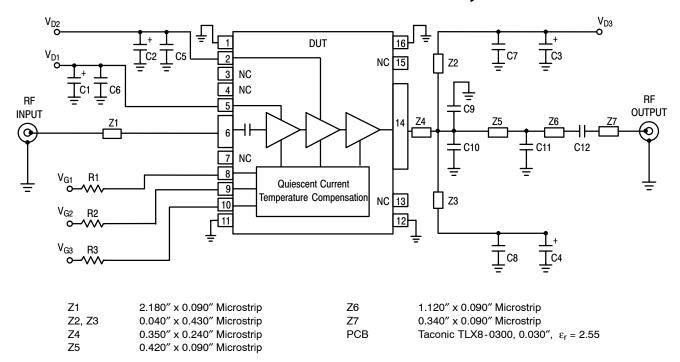


Figure 1. MW4IC2230MBR1(GMBR1) Test Circuit Schematic

Table 1. MW4IC2230MBR1(GMBR1) Test Circuit Component Designations and Values

Part	Description	Part Number	Manufacturer
C1, C2, C3, C4	10 μF, 35 V Tantalum Capacitors	TAJD106K035	AVX
C5, C6, C7, C8, C12	8.2 pF 100B Chip Capacitors	100B8R2CW	ATC
C9, C10	1.8 pF 100B Chip Capacitors	100B1R8BW	ATC
C11	0.3 pF 100B Chip Capacitor	100B0R3BW	ATC
R1, R2, R3	1.8 kΩ Chip Resistors (1206)		

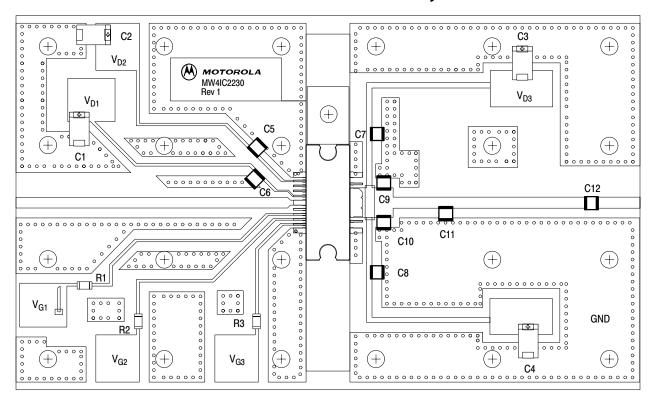


Figure 2. MW4IC2230MBR1(GMBR1) Test Circuit Component Layout

TYPICAL CHARACTERISTICS

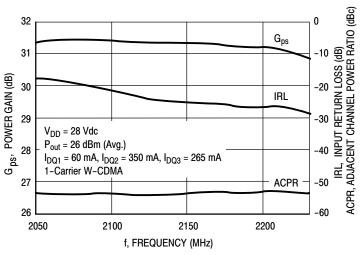


Figure 3. Single-Carrier W-CDMA Wideband Performance

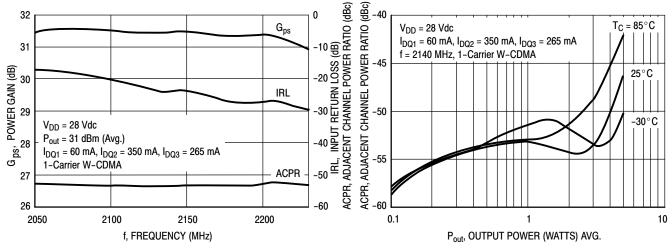


Figure 4. Single-Carrier W-CDMA Wideband Performance

Figure 5. Adjacent Channel Power Ratio versus Output Power

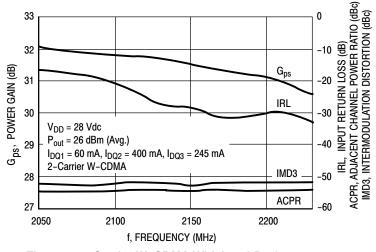
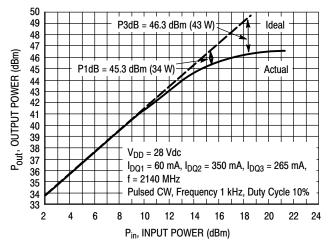


Figure 6. 2-Carrier W-CDMA Wideband Performance

TYPICAL CHARACTERISTICS



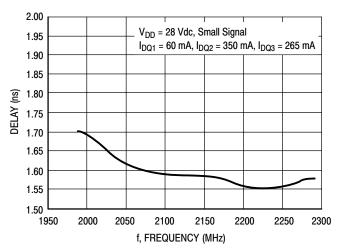
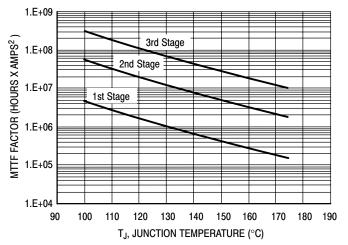


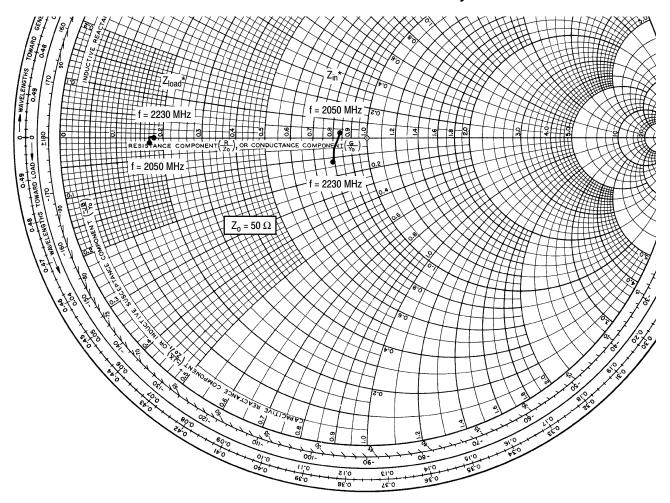
Figure 7. Output Power versus Input Power

Figure 8. Delay versus Frequency



This above graph displays calculated MTTF in hours x ampere 2 drain current. Life tests at elevated temperatures have correlated to better than $\pm 10\%$ of the theoretical prediction for metal failure. Divide MTTF factor by $l_D{}^2$ for MTTF in a particular application.

Figure 9. MTTF Factor versus Temperature Junction



 V_{DD} = 28 V, I_{DQ1} = 60 mA, I_{DQ2} = 350 mA, I_{DQ3} = 265 mA, P_{out} = 26 dBm

	DQ1	- Out
f MHz	$oldsymbol{z_{in}}{\Omega}$	$oldsymbol{Z_{load}}{\Omega}$
2050	42.18 + j1.49	8.52 - j0.46
2110	41.06 - j1.30	8.58 - j0.20
2140	40.49 - j2.42	8.63 - j0.09
2170	40.05 - j3.45	8.69 - j0.01
2230	39.29 - j6.31	8.81 + j0.04

 $Z_{in} \quad = \quad \text{Device input impedance as measured from} \\ \text{gate to ground.}$

Z_{load} = Test circuit impedance as measured from drain to ground.

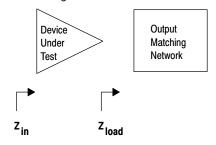
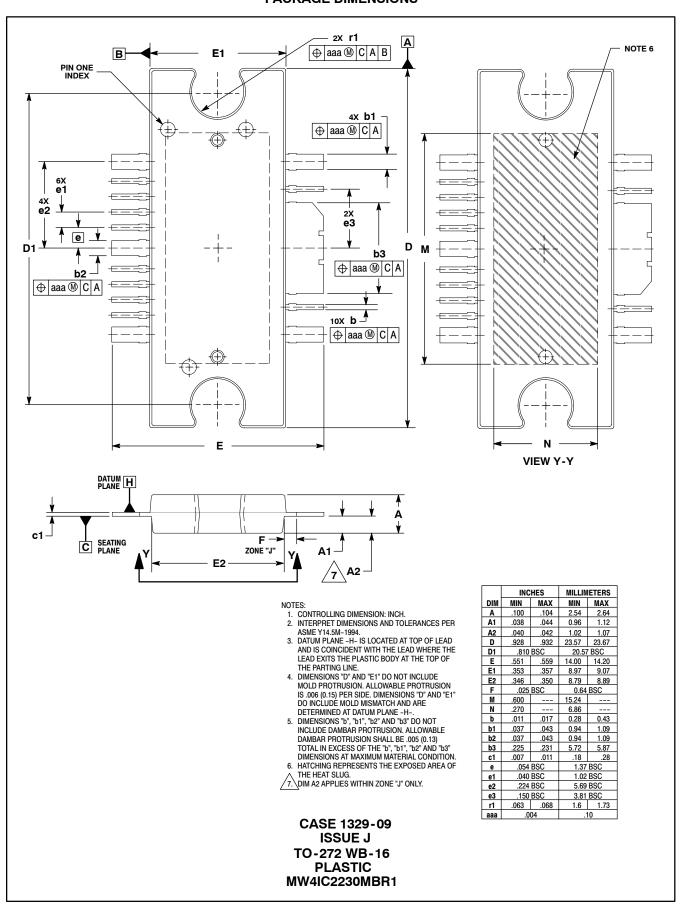
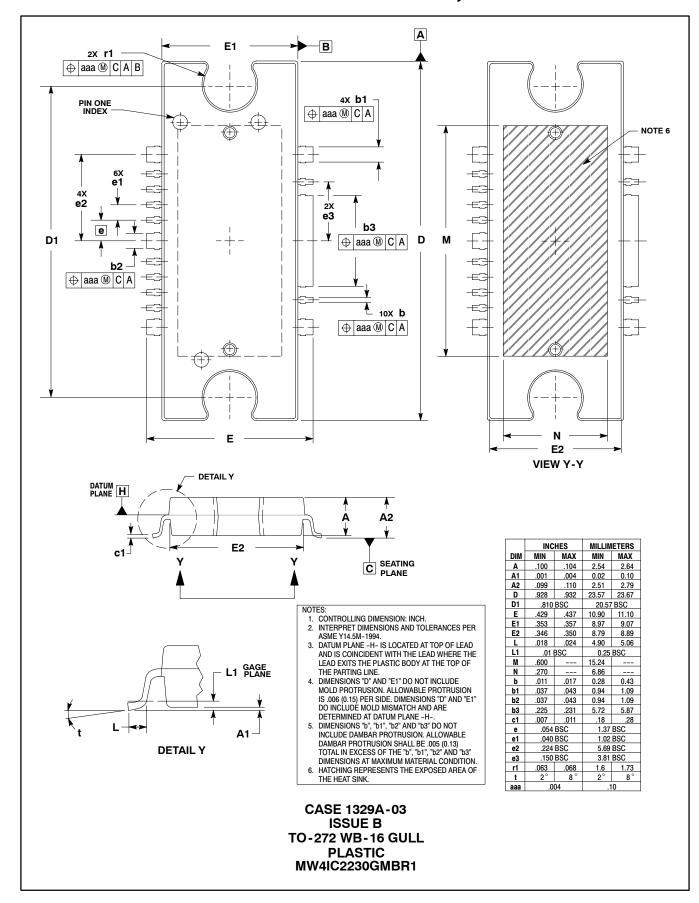


Figure 10. Series Equivalent Input and Load Impedance

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PACKAGE DIMENSIONS





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